

Inductors for standard circuits

Multilayer ferrite

MLF series (for automotive)



AEC-Q200

MLF1608 type



FEATURES

- The lineup includes a wide inductance range.
- Highly reliable monolithic structure with multilayer integration.
- Operating temperature range: -55 to +125°C

APPLICATION

- Automotive equipment, smart phones, tablet terminals, tuners, LCD-TVs, PDP-TVs, audio equipment, computers, signal processing for modules etc.

PART NUMBER CONSTRUCTION

MLF	1608	D	47N	△	T	D25
Series name	LxWxH dimensions 1.6x0.8x0.8 mm	Characteristics	Inductance (μH)	Inductance tolerance	Packaging style	Internal code

* The "△" of the Part Number contains the inductance tolerance code, J (±5%), K (±10%), or M (±20%).

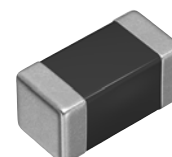
CHARACTERISTICS SPECIFICATION TABLE

L		Q		L, Q measuring conditions		Self-resonant frequency		DC resistance		Rated current	Part No.*
μH	Tolerance	min.	typ.	Frequency (MHz)	Current (mA)	(MHz)min.	(MHz)typ.	(Ω)max.	(Ω)typ.	(mA)max.	
0.047	±20%	10	20	50	1.0	600	900	0.20	0.10	200	MLF1608D47NM2D25
0.068	±20%	10	20	50	1.0	550	700	0.30	0.15	200	MLF1608D68NM2D25
0.082	±20%	10	20	50	1.0	500	650	0.30	0.15	200	MLF1608D82NM2D25
0.10	±5%	15	25	25	1.0	450	600	0.35	0.20	200	MLF1608DR10JTD25
	±10%										MLF1608DR10KTD25
	±20%										MLF1608DR10MTD25
0.12	±5%	15	25	25	1.0	400	550	0.40	0.20	200	MLF1608DR12JTD25
	±10%										MLF1608DR12KTD25
	±20%										MLF1608DR12MTD25
0.15	±5%	15	25	25	1.0	350	500	0.45	0.25	200	MLF1608DR15JTD25
	±10%										MLF1608DR15KTD25
	±20%										MLF1608DR15MTD25
0.18	±5%	15	25	25	1.0	320	450	0.50	0.25	150	MLF1608DR18JTD25
	±10%										MLF1608DR18KTD25
	±20%										MLF1608DR18MTD25
0.22	±5%	15	25	25	1.0	290	400	0.55	0.30	150	MLF1608DR22JTD25
	±10%										MLF1608DR22KTD25
	±20%										MLF1608DR22MTD25
0.27	±5%	15	25	25	1.0	260	350	0.60	0.35	150	MLF1608DR27JTD25
	±10%										MLF1608DR27KTD25
	±20%										MLF1608DR27MTD25

Measurement equipment

Measurement item	Product No.	Manufacturer
L, Q	4294A+16034G	Keysight Technologies
Self-resonant frequency	E4991A	Keysight Technologies
DC resistance	Type-7561	Yokogawa

* Equivalent measurement equipment may be used.



MLF1608 type

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L		Q		L, Q measuring conditions		Self-resonant frequency		DC resistance		Rated current	Part No.*
(μH)	Tolerance	min.	typ.	Frequency (MHz)	Current (mA)	(MHz)min.	(MHz)typ.	(Ω)max.	(Ω)typ.	(mA)max.	
0.33	±5% ±10% ±20%	15	25	25	1.0	230	320	0.75	0.40	100	MLF1608DR33JTD25 MLF1608DR33KTD25 MLF1608DR33MTD25
0.39	±5% ±10% ±20%	15	25	25	1.0	210	290	0.85	0.45	100	MLF1608DR39JTD25 MLF1608DR39KTD25 MLF1608DR39MTD25
0.47	±5% ±10% ±20%	15	30	25	1.0	190	260	0.95	0.50	100	MLF1608DR47JTD25 MLF1608DR47KTD25 MLF1608DR47MTD25
0.56	±5% ±10% ±20%	15	30	25	1.0	170	230	1.05	0.55	100	MLF1608DR56JTD25 MLF1608DR56KTD25 MLF1608DR56MTD25
0.68	±5% ±10% ±20%	15	30	25	1.0	150	210	1.25	0.65	70	MLF1608DR68JTD25 MLF1608DR68KTD25 MLF1608DR68MTD25
0.82	±5% ±10% ±20%	15	30	25	1.0	130	190	1.40	0.75	70	MLF1608DR82JTD25 MLF1608DR82KTD25 MLF1608DR82MTD25
1.0	±5% ±10% ±20%	35	50	10	1.0	120	170	0.50	0.25	50	MLF1608A1R0JTD25 MLF1608A1R0KTD25 MLF1608A1R0MTD25
1.2	±5% ±10% ±20%	35	50	10	1.0	110	150	0.65	0.25	50	MLF1608A1R2JTD25 MLF1608A1R2KTD25 MLF1608A1R2MTD25
1.5	±5% ±10% ±20%	35	55	10	1.0	100	140	0.70	0.30	50	MLF1608A1R5JTD25 MLF1608A1R5KTD25 MLF1608A1R5MTD25
1.8	±5% ±10% ±20%	35	55	10	1.0	90	130	0.85	0.35	50	MLF1608A1R8JTD25 MLF1608A1R8KTD25 MLF1608A1R8MTD25
2.2	±5% ±10% ±20%	35	55	10	1.0	80	120	1.00	0.45	30	MLF1608A2R2JTD25 MLF1608A2R2KTD25 MLF1608A2R2MTD25
2.7	±5% ±10% ±20%	35	55	10	1.0	70	110	1.15	0.50	30	MLF1608A2R7JTD25 MLF1608A2R7KTD25 MLF1608A2R7MTD25
3.3	±5% ±10% ±20%	35	60	10	1.0	65	100	1.30	0.55	30	MLF1608A3R3JTD25 MLF1608A3R3KTD25 MLF1608A3R3MTD25
3.9	±5% ±10% ±20%	35	60	10	1.0	60	90	1.45	0.65	30	MLF1608A3R9JTD25 MLF1608A3R9KTD25 MLF1608A3R9MTD25
4.7	±5% ±10% ±20%	35	60	10	1.0	55	80	1.60	0.75	30	MLF1608A4R7JTD25 MLF1608A4R7KTD25 MLF1608A4R7MTD25
5.6	±5% ±10% ±20%	35	60	4	0.1	45	70	1.10	0.55	15	MLF1608E5R6JTD25 MLF1608E5R6KTD25 MLF1608E5R6MTD25
6.8	±5% ±10% ±20%	35	60	4	0.1	40	60	1.30	0.65	15	MLF1608E6R8JTD25 MLF1608E6R8KTD25 MLF1608E6R8MTD25

Measurement equipment

Measurement item	Product No.	Manufacturer
L, Q	4294A+16034G	Keysight Technologies
Self-resonant frequency	E4991A	Keysight Technologies
DC resistance	Type-7561	Yokogawa

* Equivalent measurement equipment may be used.

MLF1608 type

CHARACTERISTICS SPECIFICATION TABLE

L	Tolerance	Q		L, Q measuring conditions		Self-resonant frequency		DC resistance		Rated current	Part No.*
		min.	typ.	Frequency (MHz)	Current (mA)	(MHz)min.	(MHz)typ.	(Ω)max.	(Ω)typ.	(mA)max.	
8.2	±5% ±10% ±20%	35	60	4	0.1	35	55	1.50	0.80	10	MLF1608E8R2JTD25 MLF1608E8R2KTD25 MLF1608E8R2MTD25
10	±5% ±10% ±20%	30	55	2	0.1	30	50	1.70	1.00	10	MLF1608E100JTD25 MLF1608E100KTD25 MLF1608E100MTD25
12	±5% ±10% ±20%	30	55	2	0.1	25	45	1.80	1.20	10	MLF1608E120JTD25 MLF1608E120KTD25 MLF1608E120MTD25
15	±10% ±20%	20	40	1	0.1	22	42	1.50	0.80	2	MLF1608C150KTD25 MLF1608C150MTD25
18	±10% ±20%	20	40	1	0.1	20	40	1.60	0.85	2	MLF1608C180KTD25 MLF1608C180MTD25
22	±10% ±20%	20	40	1	0.1	18	38	1.70	0.90	2	MLF1608C220KTD25 MLF1608C220MTD25
27	±10% ±20%	20	40	1	0.1	15	35	1.80	1.20	2	MLF1608C270KTD25 MLF1608C270MTD25
33	±10% ±20%	20	40	1	0.1	10	30	2.20	1.40	2	MLF1608C330KTD25 MLF1608C330MTD25

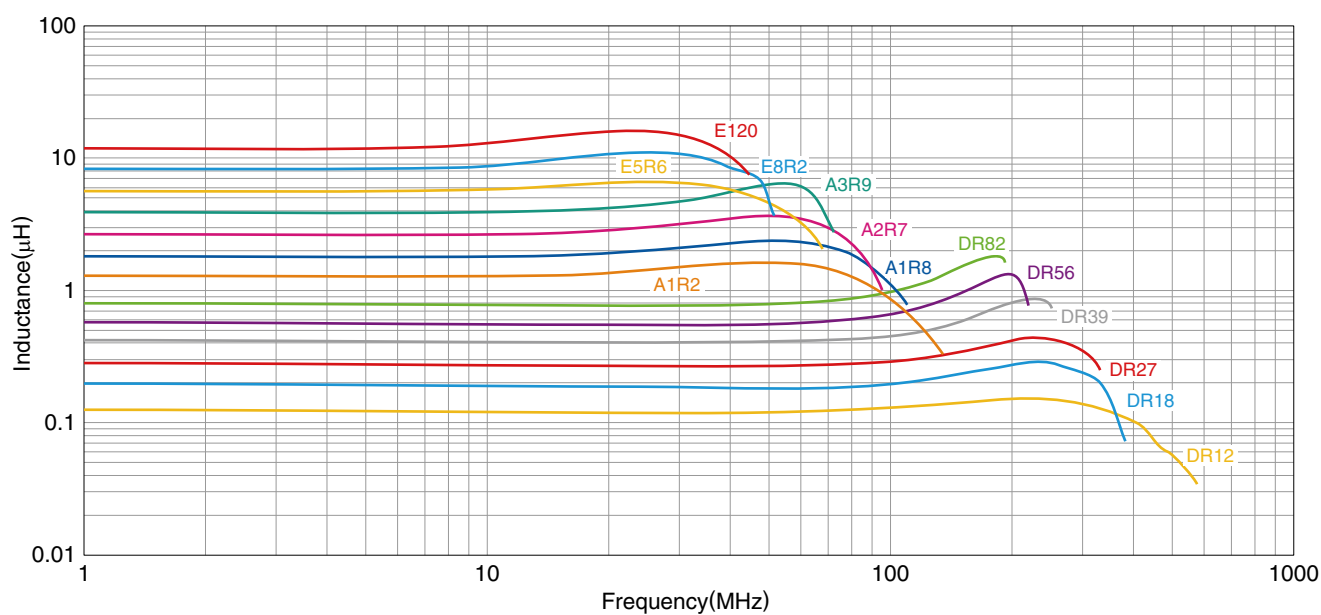
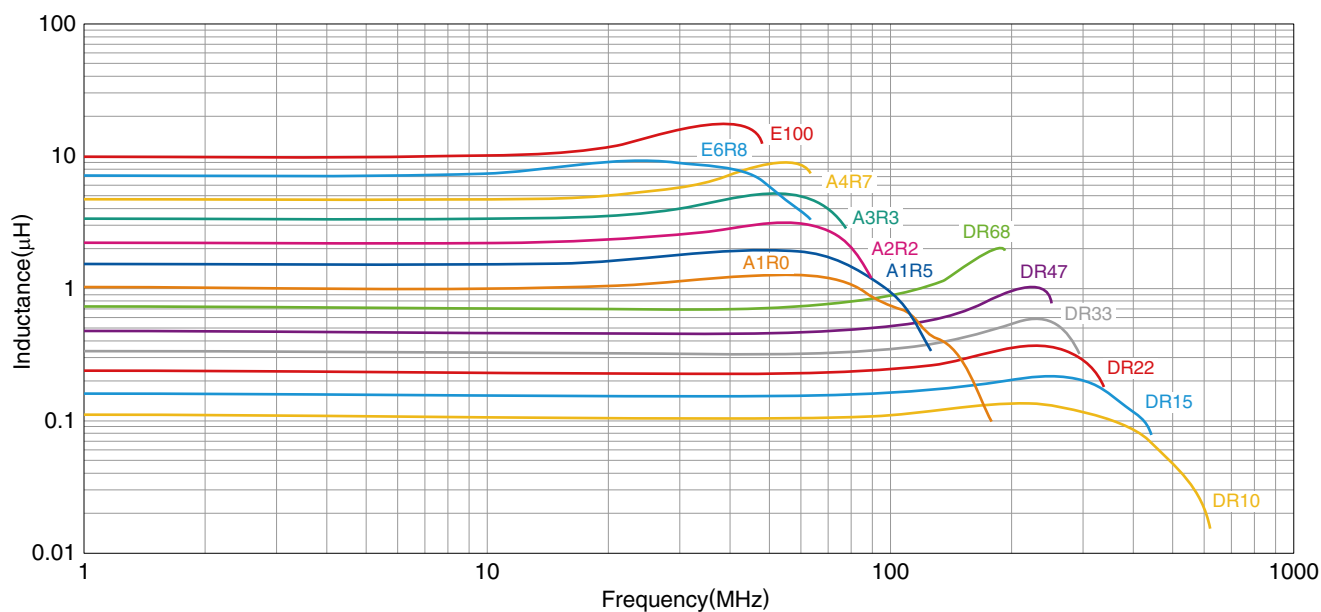
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MLF1608 type

■ L FREQUENCY CHARACTERISTICS



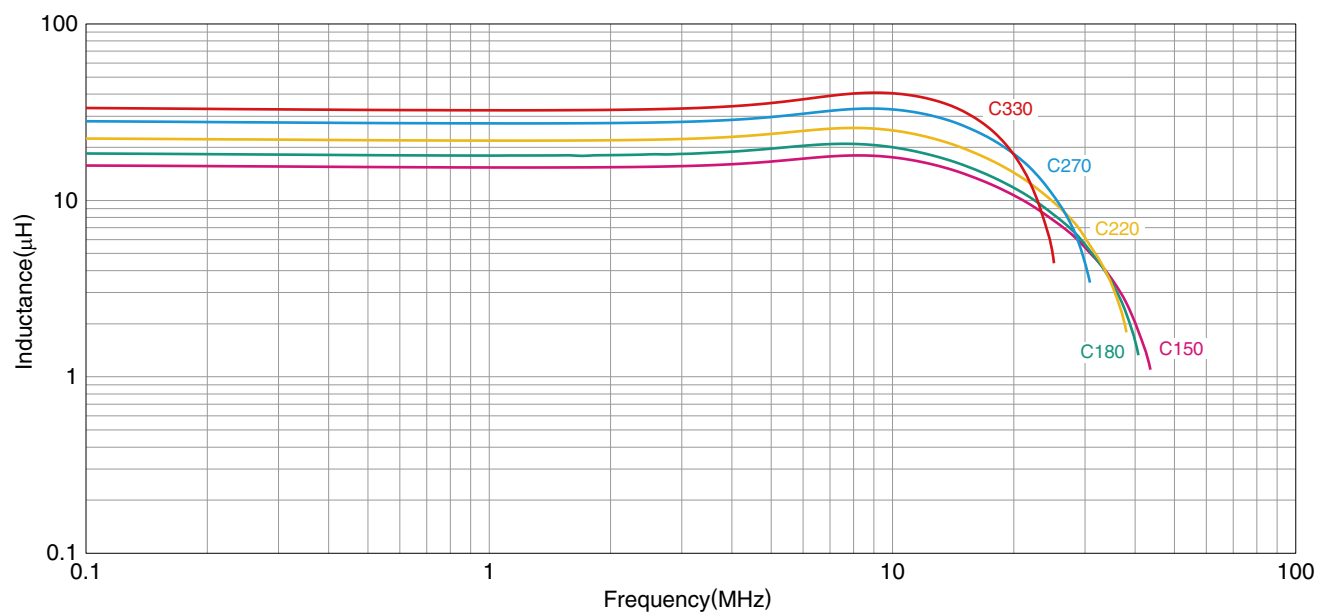
Measurement equipment

Product No.	Manufacturer
E4991A+16192A	Keysight Technologies

* Equivalent measurement equipment may be used.

MLF1608 type

L FREQUENCY CHARACTERISTICS



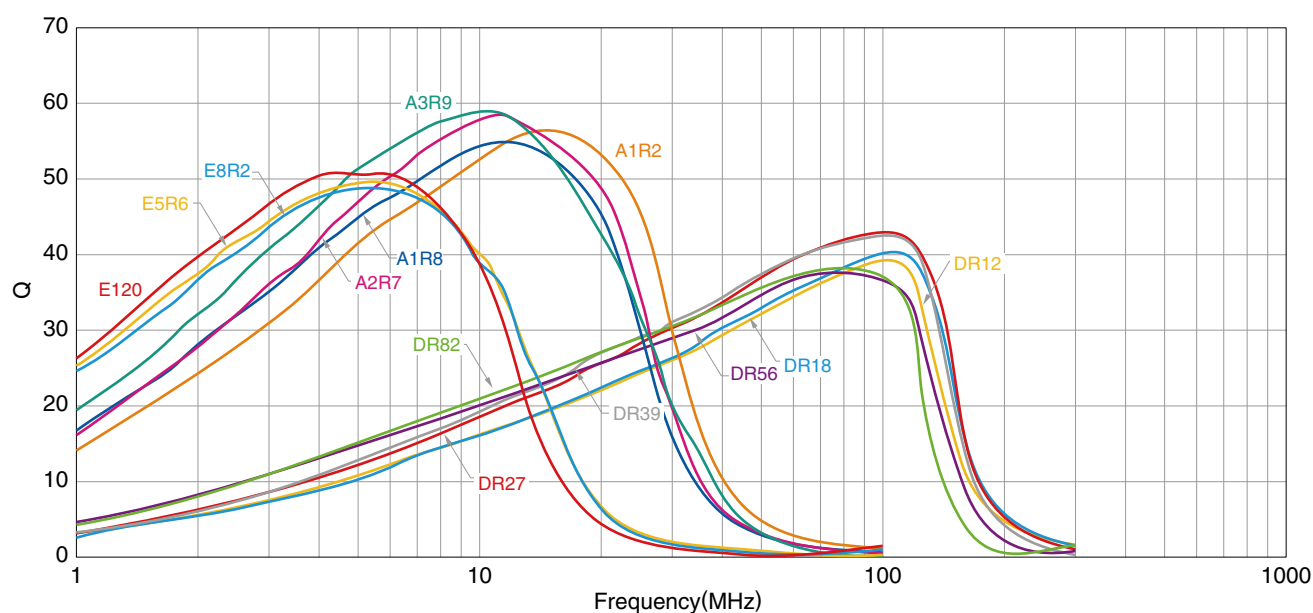
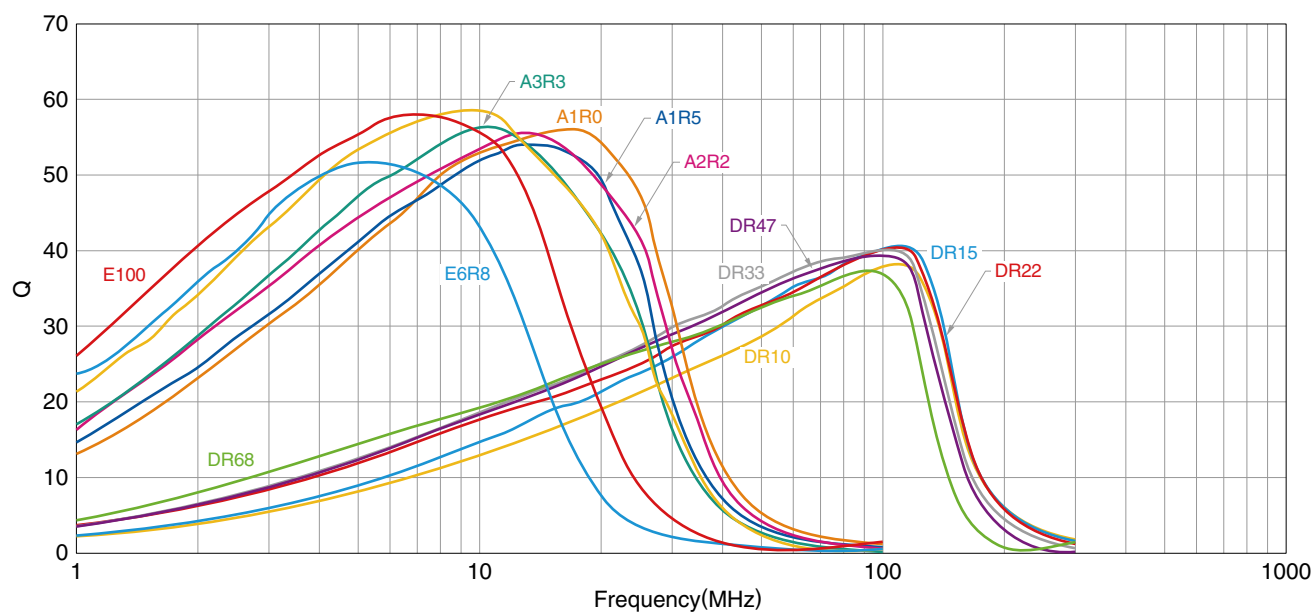
Measurement equipment

Product No.	Manufacturer
4294A+16034G	Keysight Technologies

* Equivalent measurement equipment may be used.

MLF1608 type

■ Q FREQUENCY CHARACTERISTICS

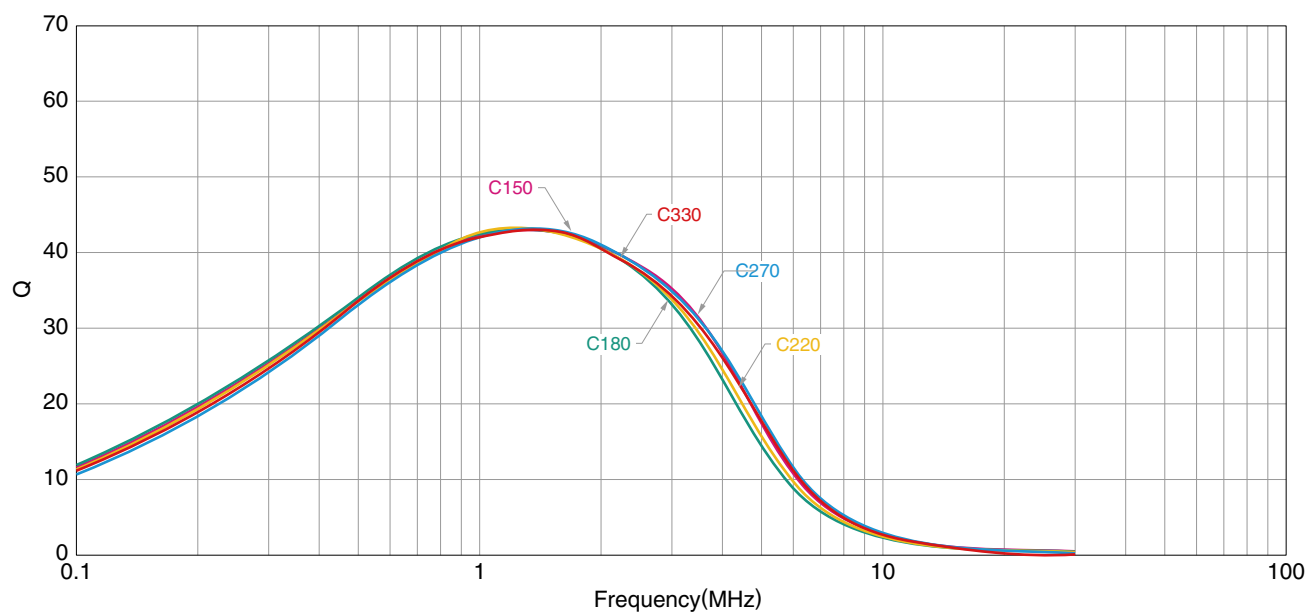


Measurement equipment

Product No.	Manufacturer
E4991A+16192A	Keysight Technologies
* Equivalent measurement equipment may be used.	

MLF1608 type

Q FREQUENCY CHARACTERISTICS



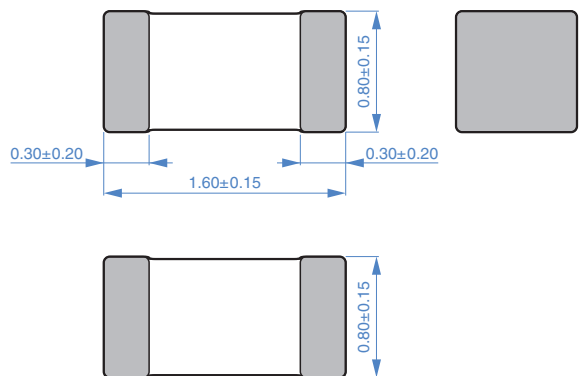
Measurement equipment

Product No.	Manufacturer
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MLF1608 type

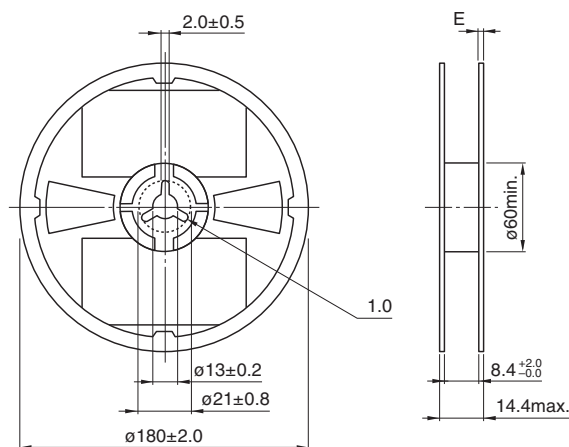
■ SHAPE & DIMENSIONS



Dimensions in mm

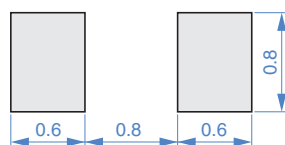
■ PACKAGING STYLE

□ REEL DIMENSIONS



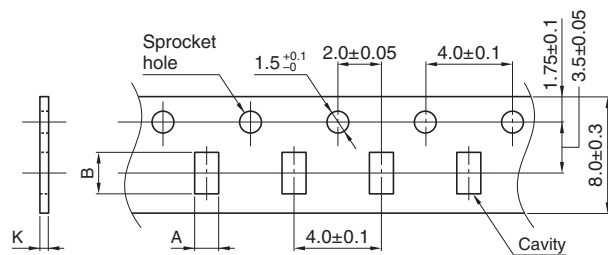
Dimensions in mm

■ RECOMMENDED LAND PATTERN



Dimensions in mm

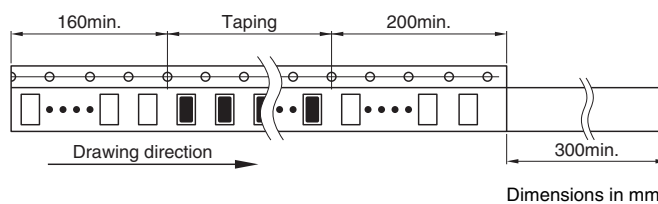
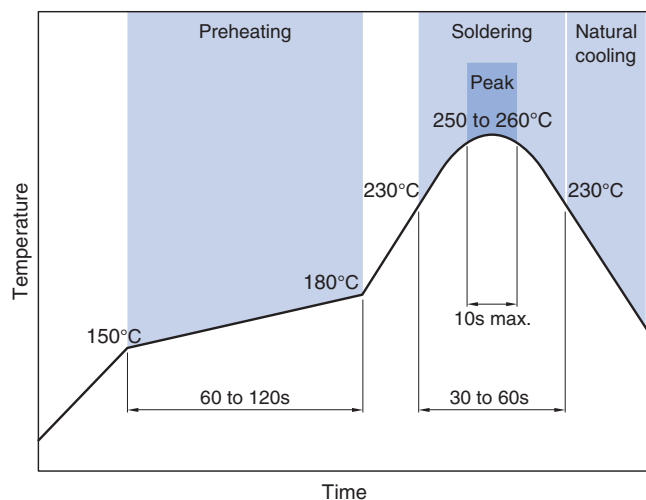
□ TAPE DIMENSIONS



Dimensions in mm

Type	A	B	K
MLF1608	1.1±0.2	1.9±0.2	1.1 max.

■ RECOMMENDED REFLOW PROFILE



Dimensions in mm

□ PACKAGE QUANTITY

Package quantity	4000 pcs/reel
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■ TEMPERATURE RANGE, INDIVIDUAL WEIGHT

Operating temperature range*	Storage temperature range**	Individual weight
-55 to +125 °C	-55 to +125 °C	4 mg

* In case the product's inductance is 15μH or higher, both operating and storage temperature ranges are -40 to +85°C.

** The storage temperature range is for after the assembly.

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

REMINDERS

- The storage period is less than 12 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH or less).
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.
The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.
A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.
The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.
If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.

- (1) Aerospace/aviation equipment
- (2) Transportation equipment (electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.